ON Semiconductor

Update Notification

Document # : FPCN20649X1
Issue Date: 15 December 2015

Title of Change:	Update to FPCN20649 - exclude NSS30101LT1G & NSS30100LT1G from Copper Wire conversion
Proposed first ship date:	15 December 2015
Contact information:	Contact your local ON Semiconductor Sales Office or <Alex.Zhang@onsemi.com>
Samples:	Contact your local ON Semiconductor Sales Office
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <S1016Z@onsemi.com>
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.
Change category:	☐ Wafer Fab Change ☒ Assembly Change ☐ Test Change ☐ Other _____

Change Sub-Category(s):

☐ Manufacturing Site Change/Addition
☐ Manufacturing Process Change
☒ Material Change
☐ Product specific change
☐ Datasheet/Product Doc change
☐ Shipping/Packaging/Marking
☐ Other: _____

Sites Affected:

☐ All site(s) ☐ not applicable ☒ ON Semiconductor site(s) : ON Leshan, China ☐ External Foundry/Subcon site(s)

Description and Purpose:

ON Semiconductor is notifying customer that NSS30101LT1G and NSS30100LT1G will be excluded and shall not undergo the Gold to Copper Wire conversion stated in FPCN20649.

List of affected Standard Parts:

NSS30100LT1G
NSS30101LT1G